



DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I declare that:

My residence, post office address, and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter that is claimed and for which a patent is sought on the invention entitled

LEAD-FREE SOLDER

of which	
[]	is attached hereto.
<u>10/824,647</u> and wa	was filed on <u>April 15, 2004</u> as patent application Serial No. <u>10/824,647</u> and was amended on <u>(if any)</u> .
[]	was filed on as PCT International Application No and was amended under PCT Article 19 on (if any).
	[]

I have reviewed and understand the contents of the specification identified above, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information that is material to the examination of the patent application identified above in accordance with 37 CFR §1.56(a).

I claim foreign priority benefits pursuant to 35 U.S.C. §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application from which priority is claimed:

Prior Foreign Application(s)				Priority Claimed		
Japan (Country)	2003-112287 (Number)			Yes <u>X</u> No		
			nth/Year Filed)	Yes No		
(Country)	(Number)	(Day/Month/Year Filed)				
I claim the bend listed below:	efit pursuant to 35 U	.S.C. §119(e) of any U	nited States provi	sional application(s)		
Application Se	rial No.	Filing Date				
Application Serial No.		Filing Date		. •		
below and, inso disclosed in the paragraph of 35 37 CFR §1.56(8	far as the subject ma prior United States U.S.C. §112, I ackr a) effective between	_	ms of this patent and the manner provinced in the manner provinced in the material in the mate	application is not		
Application Se	rial No.	Filing Date	Status (Pa	at./Pend./Aban.)		
Application Se	rial No.	Filing Date	Status (Pa	at./Pend./Aban.)		
I appoint:	:	Michael Tobias, Reg.	32948			

my attorney with full power of substitution and revocation to prosecute my application for Letters Patent identified above and to transact all business in the Patent and Trademark Office connected with that patent application.

I authorize my attorney to accept and follow instructions from S. Hirose and Associates regarding any matter related to the preparation, examination, grant, and maintenance of the application identified above, any continuation, continuation-in-part, or divisional based on the patent application identified above, and any patent issuing from that patent application, until I or my assigns withdraw this authorization in writing.

I direct that correspondence concerning this application be sent to Michael Tobias, #40, 1717 K Street N.W., Suite 613, Washington, D.C. 20036, telephone (301) 587-6541.

I declare that all statements made here based on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful, false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the patent application identified above or any patent issuing from the patent application identified above.

Full name of sole or first inventor: Masazumi AMAGAI
Inventor's signature
Date
Date
Citizenship: Japan
Post Office Address: 2-4-3, Ninomiya, Tsukuba-shi, Ibaraki, Japan
Full name of second joint inventor, if any: Masako WATANABE
Inventor's signature
Date
Residence: Oita-shi, Oita, Japan
Citizenship: Japan
Post Office Address: 7-2, Kamishiraki, Oita-shi, Oita, Japan
Full name of third joint inventor, if any: Kensho MURATA
Inventor's signature
Date
Residence: Beppu-shi, Oita, Japan
Citizenship: Japan
Post Office Address: 10kumi, Osaka, Beppu-shi, Oita, Japan

[X] Additional inventors are being named on separately numbered sheets attached hereto.

Full name of fourth joint inventor, if any: Yoshiteka TOYODA
Inventor's signature Yoshi taka Toyoda
Date <u>July 22, 2004</u> Residence: Satte-shi, Saitama, Japan Citizenship: Japan Post Office Address: 4-16-21, Kahinata, Satte-shi, Saitama, Japan
Full name of fifth joint inventor, if any: Minoru UESHIMA
Inventor's signature Minoru Ve shima
Pays
Post Office Address: 2-483-1, Takano, Misato-shi, Saitama, Japan
Full name of sixth joint inventor, if any: Tsukasa OHNISHI
Inventor's signature Toukasa Ohnishi
Dato July 22, 2005 Kesidence: Souka-shi, Saitama, Japan Citizenship: Japan
Post Office Address: 405, Yatsuka-cho, Souka-shi, Saitama, Japan
Full name of seventh joint inventor, if any: Takeshi TASHIMA
Inventor's signature Takeshi Tashima
Dato July 22.2564. Residence: Ohnojo-shi, Fukuoka, Japan
Citizenship: Japan Post Office Address: 2-9-8, Otogana, Ohnojo-shi, Fukuoka, Japan

Full name of eighth joint inventor, if any: Daisuke SOUMA Inventor's signature Residence: Haga-gun, Tochigi, Japan Citizenship: Japan Post Office Address: 2949, Takada, Ninomiya-machi, Haga-gun, Tochigi, Japan Full name of nineth joint inventor, if any: Takahiro ROPPONGI Inventor's signature Takahiro Roppongi July 27, 2004 Residence: Kawachi-gun, Tochigi, Japan Citizenship: Japan Post Office Address: 45-4, Oaza Yukigaoka, Kaminokawa-machi, Kawachi-gun, Tochigi, Japan Full name of tenth joint inventor, if any: Hiroshi OKADA Residence: Souka-shi, Saitama, Japan

Post Office Address: 405-307, Yatsuka-cho, Souka-shi, Saitama, Japan

Citizenship: Japan



Attorney Docket No.: 1061/HIROSE

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				Yes No	
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	•	Michael Tobias, Reg. 3	2 948		

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Full name of sole or first inventor: Masazumi AMAGAI Inventor's signature / masazum; Date July 3 | 200 4 Residence: Tsukuba-shi, Ibaraki, Japan Citizenship: Japan Post Office Address: 2-4-3, Ninomiya, Tsukuba-shi, Ibaraki, Japan Full name of second joint inventor, if any: Masako WATANABE Inventor's signature <u>Masako Watanalie</u> July 28, 2004 Residence: Oita-shi, Oita, Japan Citizenship: Japan Post Office Address: 7-2, Kamishiraki, Oita-shi, Oita, Japan Full name of third joint inventor, if any: Kensho MURATA Inventor's signature <u>Kensho Murata</u> Date July / 28 / 2004 Residence: Beppu-shi, Oita, Japan

Post Office Address: 10kumi, Osaka, Beppu-shi, Oita, Japan

Citizenship: Japan

[X]

Additional inventors are being named on separately numbered sheets attached hereto.

Inventor's signature
Date Residence: Satte-shi, Saitama, Japan Citizenship: Japan Post Office Address: 4-16-21, Kahinata, Satte-shi, Saitama, Japan
Full name of fifth joint inventor, if any: Minoru UESHIMA
Inventor's signature
Date
Full name of sixth joint inventor, if any: Tsukasa OHNISHI
Inventor's signature
Date Residence: Souka-shi, Saitama, Japan Citizenship: Japan Post Office Address: 405, Yatsuka-cho, Souka-shi, Saitama, Japan
Full name of seventh joint inventor, if any: Takeshi TASHIMA
Inventor's signature
Date Residence: Ohnojo-shi, Fukuoka, Japan Citizenship: Japan Post Office Address: 2-9-8, Otogana, Ohnojo-shi, Fukuoka, Japan

Full name of fourth joint inventor, if any: Yoshitaka TOYODA

Inventor's signature _____ Residence: Haga-gun, Tochigi, Japan Citizenship: Japan Post Office Address: 2949, Takada, Ninomiya-machi, Haga-gun, Tochigi, Japan Full name of nineth joint inventor, if any: Takahiro ROPPONGI Inventor's signature Residence: Kawachi-gun, Tochigi, Japan Citizenship: Japan Post Office Address: 45-4, Oaza Yukigaoka, Kaminokawa-machi, Kawachi-gun, Tochigi, Japan Full name of tenth joint inventor, if any: Hiroshi OKADA Inventor's signature ___ Date Residence: Souka-shi, Saitama, Japan

Post Office Address: 405-307, Yatsuka-cho, Souka-shi, Saitama, Japan

Full name of eighth joint inventor, if any: Daisuke SOUMA

Citizenship: Japan